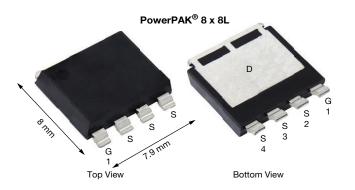
# SQJQ144AE

www.vishay.com

**Vishay Siliconix** 

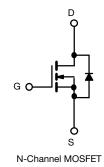
# Automotive N-Channel 40 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY	
V <sub>DS</sub> (V)	40
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 V$	0.0009
I <sub>D</sub> (A)	575
Configuration	Single
Package	PowerPAK 8 x 8L

### FEATURES

- TrenchFET<sup>®</sup> Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % R<sub>q</sub> and UIS tested
- Thin 1.6 mm package
- Very low thermal resistance
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>





ABSOLUTE MAXIMUM RATING	<b>S</b> (T <sub>C</sub> = 25 °C, unless	s otherwise noted	)			
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-source voltage		V <sub>DS</sub>	40	M		
Gate-source voltage		V <sub>GS</sub>	± 20	V		
Continuous drain current	T <sub>C</sub> = 25 °C	I	575			
Continuous drain current	T <sub>C</sub> = 125 °C	Ι <sub>D</sub>	330			
Continuous source current (diode conduction)		I <sub>S</sub>	545	А		
Pulsed drain current <sup>a</sup>		I <sub>DM</sub>	1800			
Single pulse avalanche current	ingle pulse avalanche current		60			
Single pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	180	mJ		
Maximum power dissipation	T <sub>C</sub> = 25 °C	D	600	W		
Maximum power dissipation	T <sub>C</sub> = 125 °C	P <sub>D</sub>	200	vv		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C		
Soldering recommendations (peak temperature) <sup>c</sup>			260	U		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount <sup>b</sup>	R <sub>thJA</sub>	44	°C (M)	
Junction-to-case (drain)		R <sub>thJC</sub>	0.25	°C/W	

#### Notes

c. See solder profile (<u>www.vishay.com/doc?73257</u>). The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. When mounted on 1" square PCB (FR4 material)

# SQJQ144AE



Vishay Siliconix

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	•	•		•	•		
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub>	= 0, I <sub>D</sub> = 250 μA	40	-	-	v
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	2	3	3.5	v
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	-	± 100	nA
Zero gate voltage drain current		$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V	-	-	1	
	I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V, T <sub>J</sub> = 125 °C	-	-	50	μA
		$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V, T <sub>J</sub> = 175 °C	-	-	150	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = 10 V	$V_{DS} \ge 5 V$	100	-	-	Α
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 20 A	-	0.0007	0.0009	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 20 A, T <sub>J</sub> = 125 °C	-	-	0.0015	Ω
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 20 A, T <sub>J</sub> = 175 °C	-	-	0.0019	
Forward transconductance b	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 60 A		-	160	-	S
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>			-	7220	9020	
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$	$V_{DS} = 25 V$ , f = 1 MHz	-	2290	2860	pF
Reverse transfer capacitance	C <sub>rss</sub>			-	175	220	
Total gate charge <sup>c</sup>	Qg			-	116	145	
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>	$V_{GS} = 10 V$	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 30 \text{ A}$	-	36	-	nC
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>			-	25	-	
Gate resistance	Rg		f = 1 MHz	0.9	1.6	2.6	Ω
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>			-	17	27	
Rise time <sup>c</sup>	tr	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = \text{20 V}, \ R_{\text{L}} = 0.66 \ \Omega \\ I_{\text{D}} \cong \text{30 A}, \ V_{\text{GEN}} = \text{10 V}, \ R_{\text{g}} = \text{1} \ \Omega \end{array}$		-	27	41	- ns
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>			-	41	62	
Fall time <sup>c</sup>	t <sub>f</sub>			-	18	27	
Source-Drain Diode Ratings and Cha	aracteristics <sup>b</sup>						
Reverse recovery time	t <sub>rr</sub>	V <sub>DD</sub> = 32 V, I <sub>FM</sub> = 15 A, di/dt = 100 A/µs		-	66	-	ns
Reverse recovery charge	Q <sub>rr</sub>			-	94	-	nC
Reverse recovery current	I <sub>RM</sub>		,αι = 10077μο	-	-	-3.6	Α
Pulsed current <sup>a</sup>	I <sub>SM</sub>			-	-	1600	Α
Forward voltage	V <sub>SD</sub>	I <sub>F</sub> :	= 50 A, V <sub>GS</sub> = 0	-	0.8	1.1	V

### Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

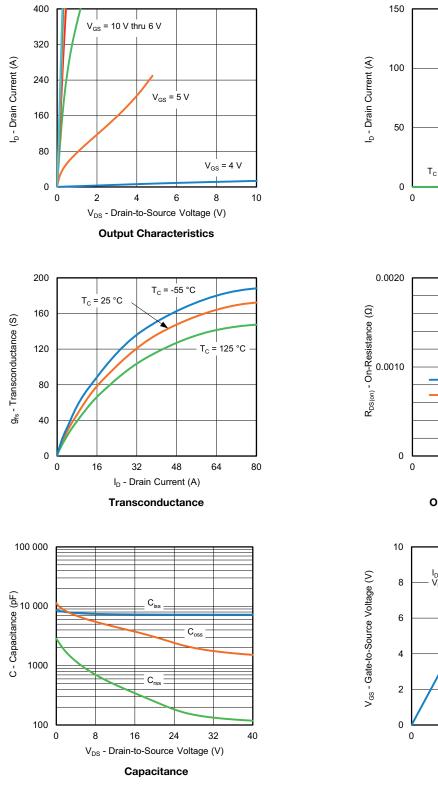
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

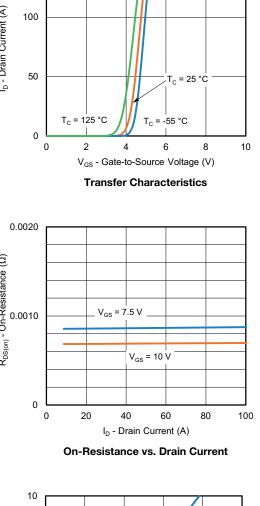
2

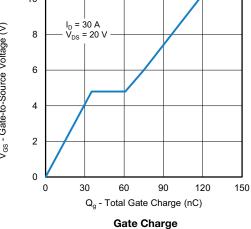


**Vishay Siliconix** 

## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)







S21-0303-Rev. D, 29-Mar-2021

3

Document Number: 77170

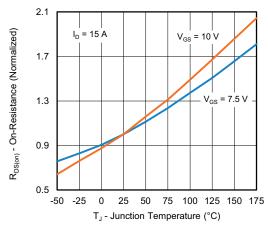
For technical questions, contact: <u>automostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFI Downloaded From <u>Oneyac.com</u> <u>w.vishay.com/doc?91000</u>



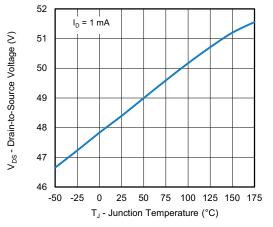
# SQJQ144AE

Vishay Siliconix

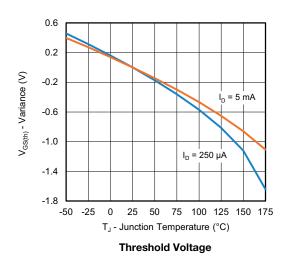
### TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C, unless otherwise noted)

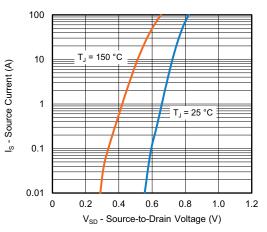


**On-Resistance vs. Junction Temperature** 

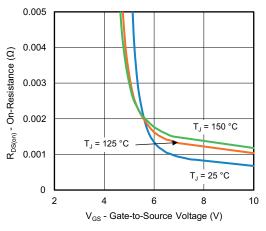


Drain Source Breakdown vs. Junction Temperature

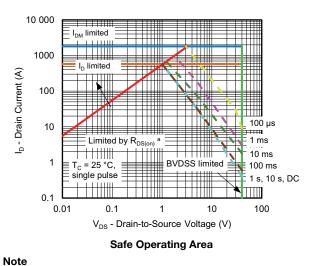




Source Drain Diode Forward Voltage



**On-Resistance vs. Gate-to-Source Voltage** 



a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

S21-0303-Rev. D, 29-Mar-2021

4

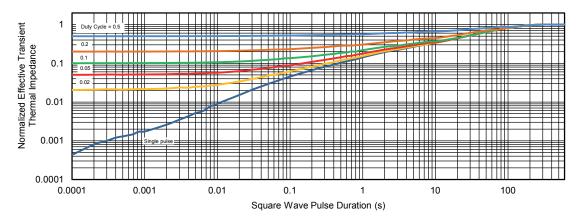
Document Number: 77170

For technical questions, contact: automostechsu <u>@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFI Downloaded From Oneyac.com w.vishay.com/doc?91000

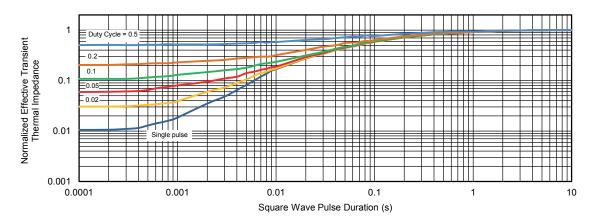


Vishay Siliconix

### THERMAL RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



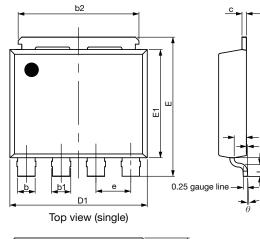
Normalized Thermal Transient Impedance, Junction-to-Case

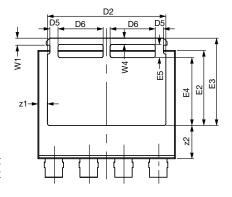
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?77170.

Vishay Siliconix

# PowerPAK<sup>®</sup> 8 x 8L BWL Case Outline 2

A1





Bottom view (single)

/		1	<b>+</b>
АРА		- A	<
ЧЦ			

DIM.	MIN. 1.50 0.00	<b>NOM.</b> 1.60	MAX.	MIN.	NOM.	MAX.
A1 A2 b	0.00	1.60		1		IVIAX.
A2 b			1.70	0.059	0.063	0.067
b		-	0.127	0.000	-	0.005
	0.655	0.705	0.755	0.026	0.028	0.030
	0.92	1.00	1.08	0.036	0.039	0.043
b1	1.02	1.10	1.18	0.040	0.043	0.046
b2	6.84	6.94	7.04	0.269	0.273	0.277
С	0.20	0.25	0.30	0.008	0.010	0.012
D1	7.80	7.90	8.00	0.307	0.311	0.315
D2	6.70	6.80	6.90	0.264	0.268	0.272
D5	0.37	0.47	0.57	0.015	0.019	0.022
D6	2.49	2.59	2.69	0.098	0.102	0.106
е	1.97	2.00	2.03	0.078	0.079	0.080
E	7.90	8.00	8.10	0.311	0.315	0.319
E1	6.12	6.22	6.32	0.241	0.245	0.249
E2	4.21	4.31	4.41	0.166	0.170	0.174
E3	4.92	5.02	5.12	0.194	0.198	0.202
E4	3.80	3.90	4.00	0.150	0.154	0.157
E5	0.65	0.75	0.85	0.026	0.030	0.033
L	0.61	0.68	0.75	0.024	0.027	0.030
L1	1.00	1.07	1.15	0.039	0.042	0.045
W1	0.30	0.40	0.50	0.012	0.016	0.020
W4	0.32	0.37	0.42	0.013	0.015	0.017
z1	0.45	0.55	0.65	0.018	0.022	0.026
z2	1.81	1.91	2.01	0.071	0.075	0.079
θ	0°	-	5°	0°	-	5°

#### Note

• Millimeter will govern

VISHAY

www.vishay.com

Revison: 05-Aug-2019

1



Vishay

## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

单击下面可查看定价,库存,交付和生命周期等信息

>>Vishay(威世)